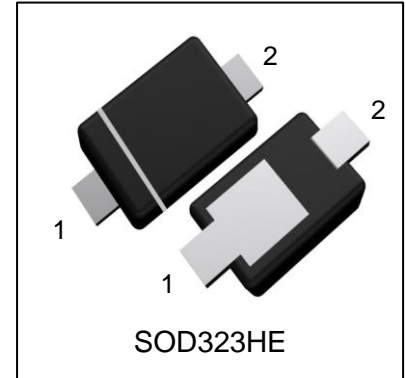


LMBR1100ET1G

S-LMBR1100ET1G

Schottky Barrier Diode



1. FEATURES

- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- S- prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q101 qualified and PPAP capable.
- Low power loss,high efficiency.
- For use in low voltage high frequency inverters,free wheeling,and polarity protection applications.
- Guardring for over voltage protection.
- High temperature soldering guaranteed:260°C/10 seconds at terminals.

2. DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
LMBR1100ET1G	110	3000/Tape&Reel
LMBR1100ET3G	110	5000/Tape&Reel
S-LMBR1100ET1G	110	3000/Tape&Reel
S-LMBR1100ET3G	110	5000/Tape&Reel

3. MAXIMUM RATINGS(Ta = 25°C)

Parameter	Symbol	Limits	Unit
Maximum repetitive peak reverse voltage	VRRM	100	V
Maximum RMS voltage	VRMS	70	V
Maximum DC blocking voltage	VDC	100	V
Maximum average forward rectified current at TC = 75°C	IF(AV)	1	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	IFSM	22	A
Typical thermal resistance (Note 1)	RθJA	210	°C/W
	RθJL	70	
Operating junction temperature range	TJ	-55 ~ +150	°C
storage temperature range	TSTG	-55 ~ +150	°C

Note: 1. 8.0mm² (.013mm thick) land areas

4. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Maximum instantaneous forward (IF = 1.0 A, TJ = 25°C)	VF	-	-	0.85	V
Maximum DC reverse current at rated DC blocking voltage TA = 25°C TJ = 125°C	IR	-	-	0.03 10	mA
Typical junction capacitance at 4.0V, 1MHz	CJ	-	160	-	pF

5. ELECTRICAL CHARACTERISTICS CURVES

Fig. 1 - Forward Current Derating Curve

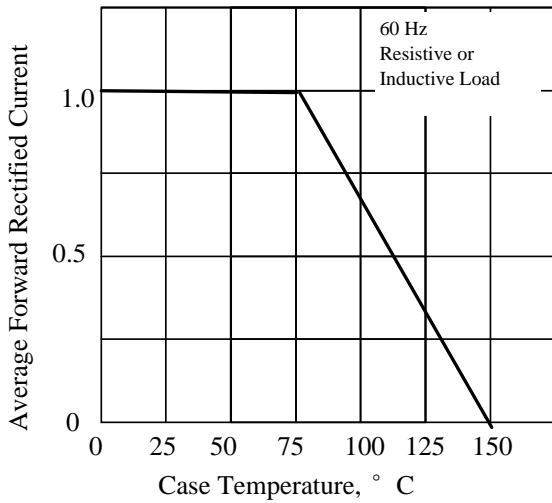


Fig. 2 - Maximum Non-repetitive Peak Forward Surge Current

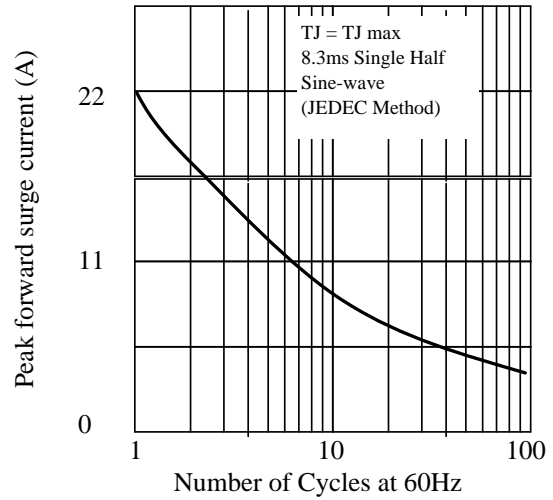


Fig 3. - Typical Instantaneous Forward Characteristics

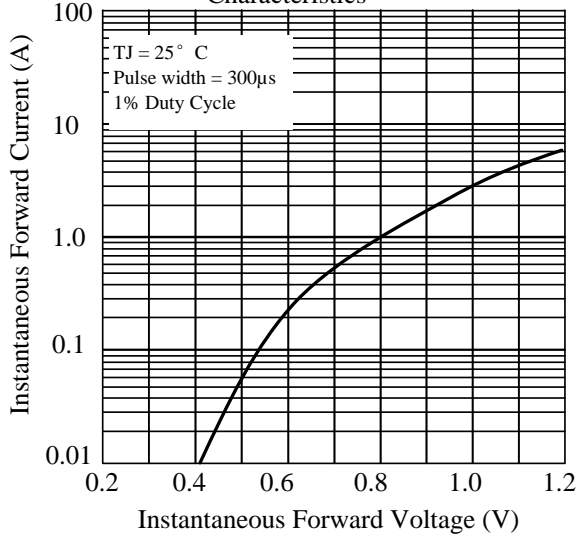


Fig 4. - Typical Reverse Characteristics

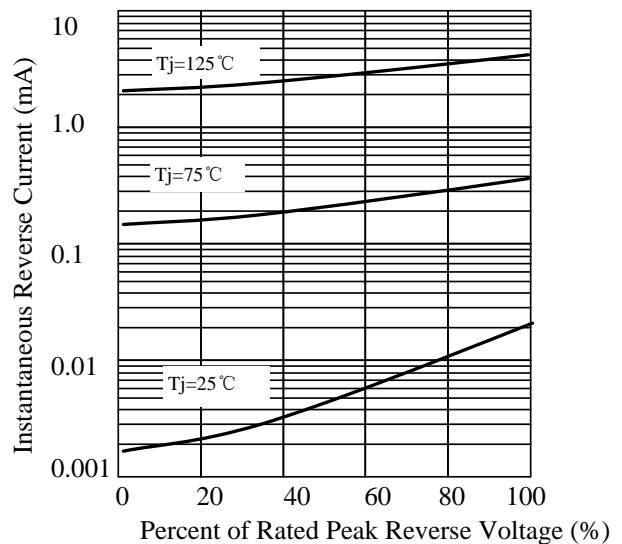


Fig 5. - typical transient thermal impedance

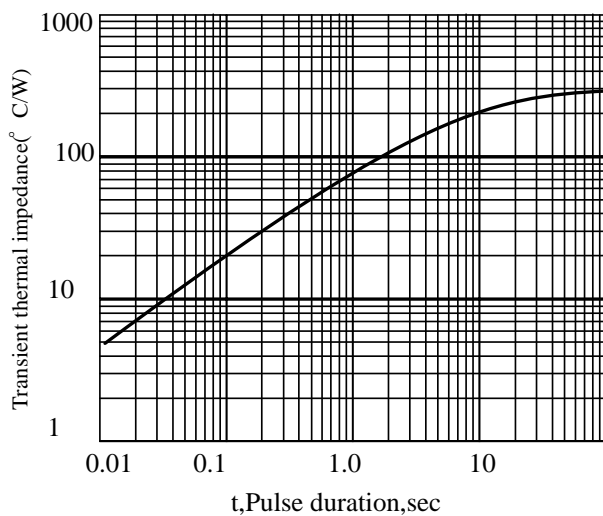
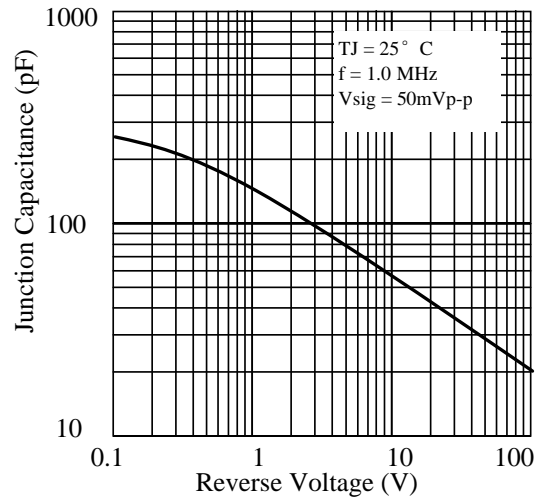
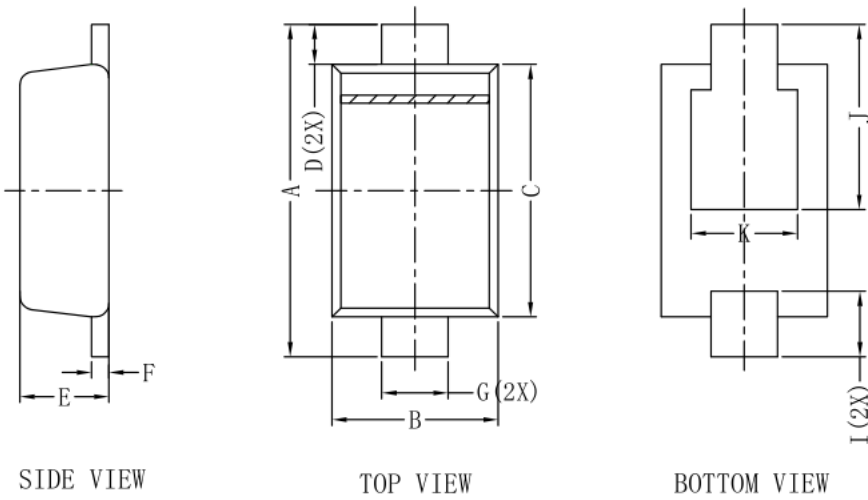


Fig 6. - Typical Junction Capacitance



6. OUTLINE AND DIMENSIONS



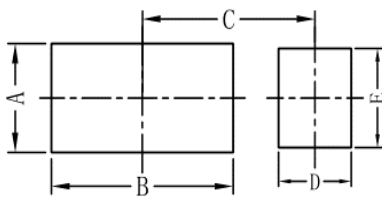
SOD323HE			
DIM	MIN	MAX	Typ.
A	2.30	2.70	2.55
B	1.20	1.35	1.25
C	1.75	1.95	1.90
D	-	-	0.30
E	0.55	0.75	0.67
F	0.10	0.20	0.15
G	0.45	0.65	0.50
I	0.40	0.70	0.50
J	1.15	1.55	1.40
K	-	-	0.80
All Dimensions in mm			

GENERAL NOTES

1. Top package surface finish $Ra0.4 \pm 0.2 \mu m$
2. Bottom package surface finish $Ra0.7 \pm 0.2 \mu m$

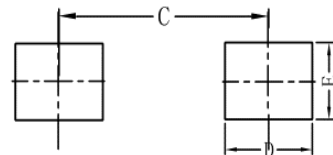
7. SOLDERING FOOTPRINT

RECOMMENDED PAD



SOD323HE	
DIM	(mm)
A	1.1
B	2.0
C	1.9
D	0.8
E	1.0

COMPATIBLE PAD



SOD323HE	
DIM	(mm)
D	1.0
E	0.8
C	2.4

DISCLAIMER

- Curve guarantee in the specification. The curve of test items with electric parameter is used as quality guarantee. The curve of test items without electric parameter is used as reference only.
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- All information contained in this document is current as of the issuing date and subject to change without any prior notice. Before purchasing or using LRC's Products, please confirm the latest information with a LRC sales representative.

单击下面可查看定价，库存，交付和生命周期等信息

[>>LRC\(乐山无线电\)](#)